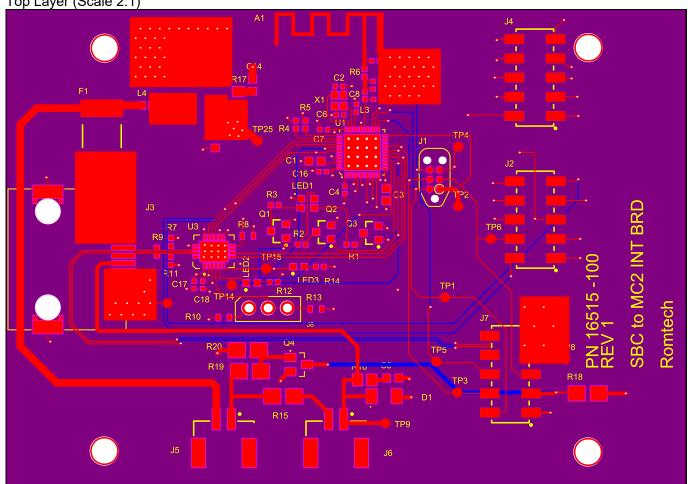
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REV	Description	Date	Appr		
1.0	1. Initial release	3/14/2023	FKA		

Top Layer (Scale 2:1)



Notes: (All Dimensions are in mm)

- 1. Board Material FR-4
- 2. Class 2 circuit board per IPC standards, current revision
- 3. All dimensional tolerances per IPC-2615
- 4. All plating per IPC-6011 class 2 1 oz finished copper
- 5. SMOBC ENIG, 2-8 micro inches gold over 150-250 micro inches nickel per IPC-4552, category 2, on all exposed copper
- 6. LPI solder mask both sides green per IPC-sm-840c
- 7. Silkscreen top and bottom sides with white epoxy ink
- 8. Boards to be U.L. recognized (zpmv2); with minimum flammability rating of 94V-0; and shall be so marked
- 9. All boards to be cleaned, inspected, and date stamped
- 10. Workmanship to be equal to and compliant with the requirements of IPC-A-610
- 11. Boards to be electrical tested per IPC- 9252 and marked or stamped to show that the board passed.

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12. Boards should be RoHs compliant

			UNLESS OTHERWISE SPECIFIED:		NAME	DATE	DOMToch					
			DIMENSIONS ARE IN mm TOLERANCES:	DRAWN		3/14/2023			ROMTech			
			FRACTIONAL±	CHECKED			TITLE SBC_TO_MC2_PCB					
			ANGULAR: MACH± BEND ± TWO PLACE DECIMAL ±	ENG APPR.								
THE INFORMATION CONTAINED IN			THREE PLACE DECIMAL ±	MFG APPR.								
THIS DRAWING IS THE SOLE			INTERPRET GEOMETRIC TOLERANCING PER: MATERIAL	Q.A.								
PROPERTY OF ROMTech. ANY REPRODUCTION IN				COMMENTS:			SIZE	DWG. NO.			Rev	
PART OR AS A WHOLE WITHOUT THE WRITTEN PERMISSION OF	NEXT ASSY	USED ON	FINISH					16515-100			1	
PROPRIETARY AND CONFIDENTIAL	APPLICATION		DO NOT SCALE DRAWING				SCALE:	1:1	WEIGHT:	SHE	ET 1 OF 9	

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